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**General Information**

Series	SMD Comm COG HV Flex
Style	SMD Chip
Description	SMD, MLCC, FT-CAP, Ultra-Stable
Features	FT-CAP, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
Typical Component Weight	320 mg
Shelf Life	78 Weeks
MSL	1

**Specifications**

Capacitance	0.022 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	10%
Voltage DC	630 VDC
Dielectric Withstanding Voltage	945 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	45.4545 GOhms

**Dimensions**

L	5.9mm +/-0.75mm
W	5mm +/-0.4mm
T	2.5mm +/-0.20mm
S	3.5mm MIN
B	0.7mm +/-0.35mm
Case Code (EIA / mm)	2220 / 5651

**Packaging Specifications**

Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	500

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